3DAXI AUTOMATED X-RAY INSPECTION

TR7600 SIII SERIES



Ultra-High Speed
3D CT X-Ray Inspection



Ultimate Resolution AXI for Large Boards



Smart Programming with Robust Algorithms









TR7600 SIII SERI



High Performance 3D AXI for Large PCB Assemblies

The TR7600 SIII series is TRI's hallmark inline line scan 3D AXI, with CT capabilities specialized, designed for the inspection of larger board sizes, up to 1200 mm x 660 mm. The TR7600 SIII series delivers industry's fastest high resolution imaging performance and great image quality in the industry's most advanced automatic X-ray inspection.



Large Board Inspection

A perfect fit for multiple industries.







Smart Programming

The new 3D AXI intuitive software helps set up inspection programs based on CAD data. The TR7600 SIII series is equipped with TRI's extensive smart component library, reducing engineer workload and minimizing production downtime.















Library Editor

Board View Scan

Fid Mark

FOV scan

Library Review

Warp

Fine Tuning

High Resolution Design for Maximum Defect Detection

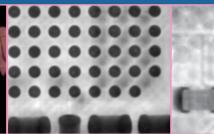
The TR7600 SIII series enhanced 3D inspection with planar CT imaging can recreate a complete 3D model of each solder joint, enabling clear analysis of shape irregularities, head-in pillow and voiding problems. Vertical cross-section CT images help with reliable visual review of borderline and buried solder joints.



BGA short / open 3D CT Inspection



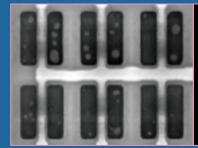
THT 3D CT Inspection



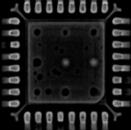
PoP soldering Inspection



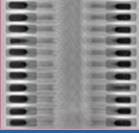
Chip Inspection



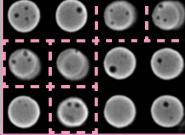
Void Inspection of LED



QFN 3D CT Inspection



DIMM Connector Inspection



BGA HiP Defect



ES

Board Warpage Control

The AXI solution uses multiple laser sensors to measure PCB assembly deformations and adjusts component inspection parameters to compensate for the board warpage.

Top of the Line Repair Station

The AXI repair station collects a wide range of inspection data and offers statistical feedback that enhances the efficiency of the inspection process.

Defect Viewer Top Trends

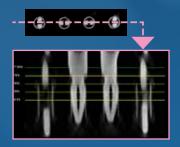
History Data Yield Chart

Ease of Maintenance

The high-reliability robust platform and advanced automatic/scheduled calibration with detail reporting ensure ease of maintenance.



PressFit Connector Inspection







Press-fit 3D CT Inspection

TRI AXI solutions can accurately inspect and detect missing, insufficient penetration and askew in press-fit connectors. The press-fit connector inspection can individually detect defects in individual slices and viewed in high detail as 3D CT images. The automotive and telecommunications industries greatly benefit from an accurate press-fit inspection as their robust boards are commonly present in them (e.g., communication servers and automotive sensors).

Big Data Ready

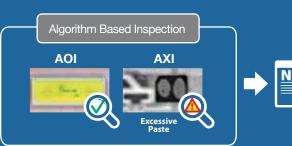


Boost your factory intelligence and optimize your production line by easily integrating big data analytics from your solutions. TRI's smart factory test and inspection solutions promote full traceability and data exchange, by generating big data for your MES applications, essential for optimizing your production your yield rate, enabling the connected factory.

YMS 4.0 - Smart Review System

Yield Management System (YMS) 4.0 reduce operator re-inspection with the smart review system module. The intelligent defect review module is an algorithm-based solution that offers real time reporting to improve defect management and yield rate.





YMS 4.0 - Smart Monitoring

TRI's smart factory solutions allow operators to aggregate information from individual systems for statistical analysis of production line defect rates, reviewing and fine-tuning inspection results, and identifying component defect trends and emerging production issues.



Production Analysis



Centralized Inspection
Center



Real Time SPC Trends

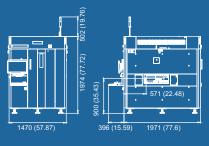


TR7600 SIII SERIES

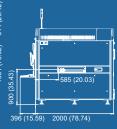
Model				
	Camera			
Imaging System	X-ray Source			
	Imaging Resolution			
	Inspection Method			
Inspection Functions	Components			
	Defects			
X-Y-Z-Axis Control				
Max. PCB Size				
PCB Thickness				
PCB Transport Height				
Max PCB Weight				
PCB Carrier / Fixing				
Clearance	Тор			
	Bottom			
	Edge			
Weight				
Power Requirement				
X-ray Leakage				
Air Requirement				
Optional Features				

TR7600 S	III I		TR7600LL SIII		T	R7600TL SIII	
Ultra-High Speed Line-Scan CCD Cameras							
3 or 5 Units (9 or 15 Sensors)							
60 -130 kV 7 μm - 20 μm							
7 μπ - 20 μπ 2D, 2.5D, 3D Slicing, Planar CT (Optio							
BGAs, Barrel fill, Capacitors, Chips, Components Under RF shields, WLCSP, DIMM Connectors,							
Flip-Chips, Ground Pads, Gullwing, Heat sinks, J-Leads, LED Chips, LGAs, Paladin Connector, Resistor,							
RNET, SiP, SMT Connectors, SOIC, SOT, Thermal Pad, QFNs, QFP and THTs							
Missing, Misalignment, Tombstone, Billboard, Tantalum Polarity, Rotation, Foreign Material,							
Insufficient/Excess Solder, Bridging, Open, Solder Ball, Non-Wetting, Void and Lifted Lead							
High-Precision Ballscrew + AC-Servo Controller							
900 x520 mm (35.43 x 20.47 in.) 1000 x 660 mm (39.37 x 25.98 in.) 1200 x 660 mm (47.24 x 25.98 in.)							
12 kg (26.46 lb)							
Step Motor Driven / Pneumatic Clamping							
7 μm	10 μm		15 μm		20 μm	25 μm	
7 mm (0.28 in.)	15 mm (0.59	in.)	30 mm (1.18 in.)		50 mn	n (1.97 in.)	
70 mm (2.76 in.)				55 mm (2.17 in.)			
3 mm (0.12 in.) or 5 mm (0.20 in.)							
3850 kg (8487	7.8 lb)	4500 kg (9920.8 lb) 4750 kg (10,471.96 lk		kg (10,471.96 lb)			
200 - 240 VAC Sing	gle phase,	200 – 240 V _{LL} , Three Phases 4 W, 50 / 60Hz, 7.0 kVA					
50/60 Hz, 4 kVA Optional: 346 – 416 V _{LL} Three Phase Transformer							
< 0.5 μSV/h							
72 psi – 87 psi (5 – 6 bar)							
Barcode Scanner, Repair Station, Offline Editor, Yield Management System (YMS 4.0),							
CAD Converter and CT Imaging, AI Solutions							

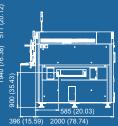
Unit: mm (in.)











TR7600 SIII

TR7600LL SIII

TR7600TL SIII

Global Network

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TRI * 德律 * TRI INNOVATION *

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